This application provides dual duct constant or variable volume discharge control. When the space temperature is warm, the cold damper maintains maximum cooling setpoint while the hot damper maintains minimum heating airflow setpoint. As the space temperature drops, the cold damper modulates closed while the hot damper opens. As the space temperature continues to fall, the cold damper maintains minimum cooling airflow setpoint and the hot damper maintains maximum heating airflow setpoint. Airflow limits for the cold deck are located on the ETPCV2 module. Total airflow limit is located on the ETPCV2 module. Heating minimum airflow limit is set by the difference in cold deck maximum and total airflow limits.

